

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
Yung-Tin Chen		08/31/2006
RECEIVING PARTY DATA		
Name:	SanDisk Corporation	
Street Address:	601 McCarthy Boulevard	
City:	Milpitas	
State/Country:	CALIFORNIA	
Postal Code:	95035	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	11470359	
CORRESPONDENCE DATA		
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>		
Email:	awinefield@pgpatent.com	
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ATTORNEY DOCKET NUMBER:	1033-012575-US (PAR)	
NAME OF SUBMITTER:	Geza C. Ziegler, Jr.	
Total Attachments: 2 source=Assignment#page1.tif source=Assignment#page2.tif		

CH \$40.00 11470359

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PATENT
REEL: 018210 FRAME: 0383

Assignment of Rights in Invention
(Sole inventor; single assignee, without witness or notarization)

Docket No.
1033-012575-US (PAR)

Inventor

CHEN, Yung Tin

Residence of Inventor

4190 Tobin Circle
Santa Clara, CA 95054

Assignee

SanDisk Corporation

Residence or Principal Place of Business of Assignee

601 McCarthy Boulevard
Milpitas, CA 95035

Whereas, I, the above-identified Inventor, have invented certain new and useful improvements in:
METHOD OF MASK MAKING TO PREVENT PHASE EDGE FOR CHROME-LESS PHASE SHIFTING MASK

(hereinafter referred to as "Invention") for which I am making application for Letters Patent in the United States of America;

And, whereas I desire to assign a 100% undivided interest in said Invention, said application disclosing the Invention and any Letters Patent which may be granted therefor to the above-identified Assignee, and whereas said Assignee is desirous of acquiring the entire right, title and interest in the same;

Now, this indenture witnesseth, that for the sum of **One** *dollars*
(\$ 1.00), and other good and valuable consideration, the receipt whereof is hereby acknowledged;

I hereby assign, sell and transfer a 100% undivided interest in said invention, said application, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said Invention, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And I hereby authorize and request the Commissioner of Patents and Trademarks to issue said United States Letters Patent to said Assignee, as assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary and lawful future documents, including assignments in favor of Assignee, or its designees as Assignee or its Assignees may from time-to-time present to me in order to perfect title in said Invention, modifications, and improvements in said Invention, applications and Letters Patent of the United States and countries foreign thereto;

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(Sole inventor; single assignee; without witness or notarization)

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Inventor

CHEN, Yung Tin

Residence of Inventor

4190 Tobin Circle
Santa Clara, CA 95054

Assignee


SanDisk Corporation

Residence or Principal Place of Business of Assignee

601 McCarthy Boulevard
Milpitas, CA 95035

And I further agree to sign and properly execute such necessary and lawful papers for application for foreign patents, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee thereof shall hereafter require and prepare at its own expense.

Executed this day of , in the year
at

 8/31/2006
(Signature of Inventor)